



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



MPSA63, MPSA64

MPSA64 is a Preferred Device

Darlington Transistors

PNP Silicon

Features

- These are Pb-Free Devices*

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|----------------|-------------|----------------------------|
| Collector-Emitter Voltage | V_{CES} | -30 | Vdc |
| Collector-Base Voltage | V_{CBO} | -30 | Vdc |
| Emitter-Base Voltage | V_{EBO} | -10 | Vdc |
| Collector Current - Continuous | I_C | -500 | mAdc |
| Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 625 5.0 | mW mW/ $^\circ\text{C}$ |
| Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C | P_D | 1.5 12 | W mW/ $^\circ\text{C}$ |
| Operating and Storage Junction Temperature Range | T_J, T_{stg} | -55 to +150 | $^\circ\text{C}$ |

THERMAL CHARACTERISTICS

| Rating | Symbol | Max | Unit |
|---|-----------------|------|---------------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 200 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 83.3 | $^\circ\text{C}/\text{W}$ |

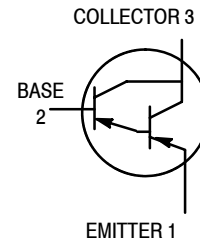
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

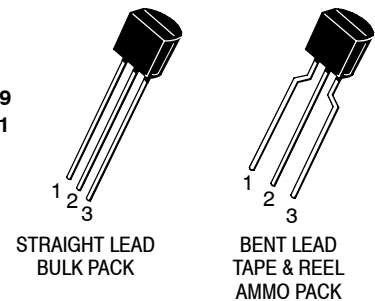


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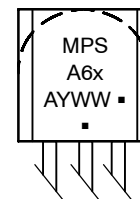
<http://onsemi.com>



TO-92
CASE 29
STYLE 1



MARKING DIAGRAM



- xx = 3, or 4
- A = Assembly Location
- Y = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

MPSA63, MPSA64

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|--|------------------|----------|------------------|--------|
| OFF CHARACTERISTICS | | | | |
| Collector-Emitter Breakdown Voltage ($I_C = -100 \mu\text{Adc}$, $V_{BE} = 0$) | $V_{(BR)CES}$ | -30 | - | Vdc |
| Collector Cutoff Current ($V_{CB} = -30 \text{ Vdc}$, $I_E = 0$) | I_{CBO} | - | -100 | nAdc |
| Emitter Cutoff Current ($V_{EB} = -10 \text{ Vdc}$, $I_C = 0$) | I_{EBO} | - | -100 | nAdc |
| ON CHARACTERISTICS (Note 1) | | | | |
| DC Current Gain ($I_C = -10 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$) | MPSA63 MPSA64 | h_{FE} | 5,000 10,000 | - - |
| ($I_C = -100 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$) | MPSA63 MPSA64 | | 10,000 20,000 | - - |
| Collector-Emitter Saturation Voltage ($I_C = -100 \text{ mAdc}$, $I_B = -0.1 \text{ mAdc}$) | $V_{CE(sat)}$ | - | -1.5 | Vdc |
| Base-Emitter On Voltage ($I_C = -100 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$) | $V_{BE(on)}$ | - | -2.0 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | | | | |
| Current-Gain — Bandwidth Product (Note 2) ($I_C = -100 \text{ mAdc}$, $V_{CE} = -5.0 \text{ Vdc}$, $f = 100 \text{ MHz}$) | f_T | 125 | - | MHz |

1. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$; Duty Cycle $\leq 2.0\%$.
2. $f_T = |h_{fe}| \cdot f_{test}$.

ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|--------------------|--------------------|
| MPSA63G | TO-92 (Pb-Free) | 5000 Units / Bulk |
| MPSA63RLRAG | TO-92 (Pb-Free) | 2000 / Tape & Reel |
| MPSA64G | TO-92 (Pb-Free) | 5000 Units / Bulk |
| MPSA64RLRAG | TO-92 (Pb-Free) | 2000 / Tape & Reel |
| MPSA64RLRMG | TO-92 (Pb-Free) | 2000 / Ammo Pack |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MPSA63, MPSA64

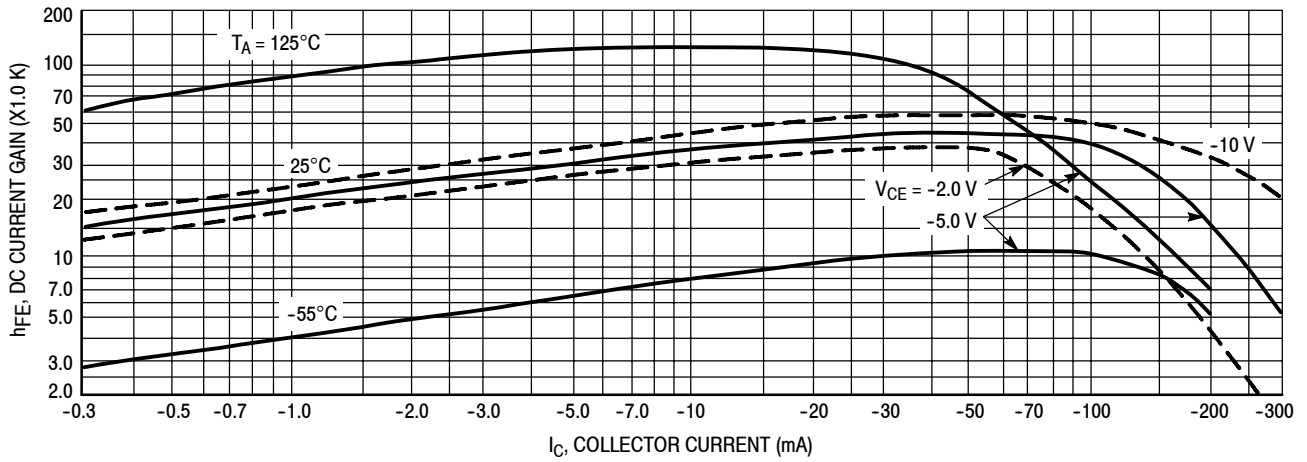


Figure 1. DC Current Gain

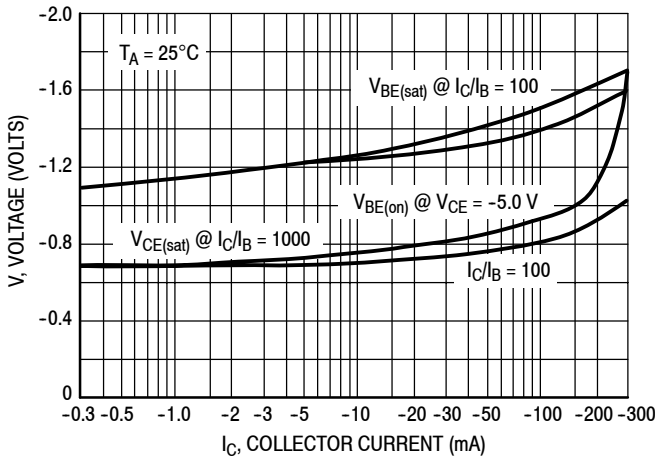


Figure 2. "On" Voltage

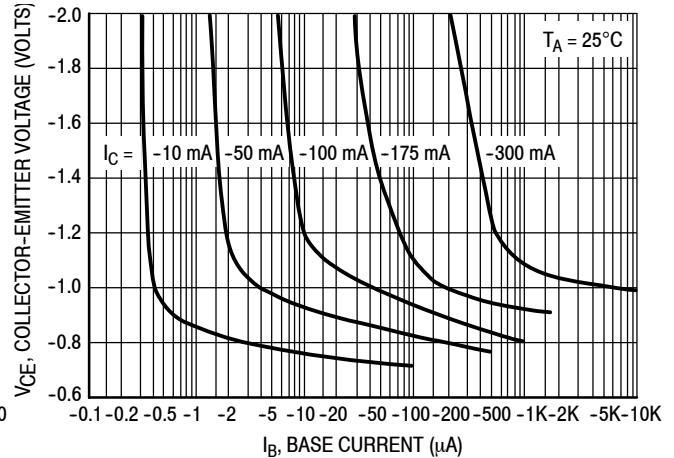


Figure 3. Collector Saturation Region

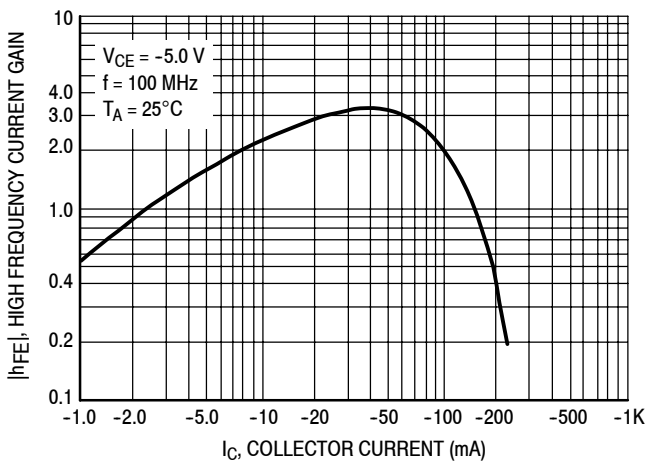


Figure 4. High Frequency Current Gain

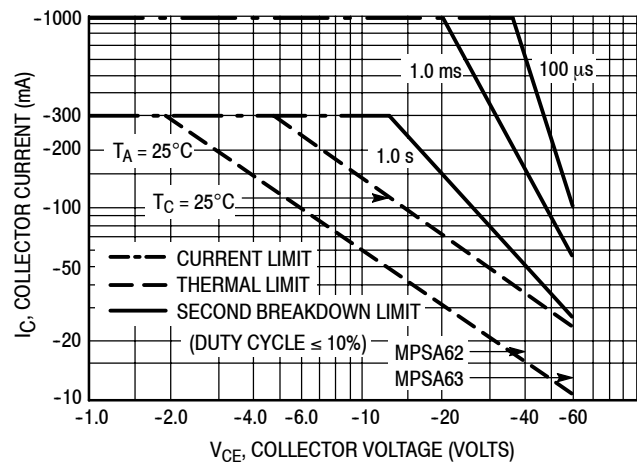
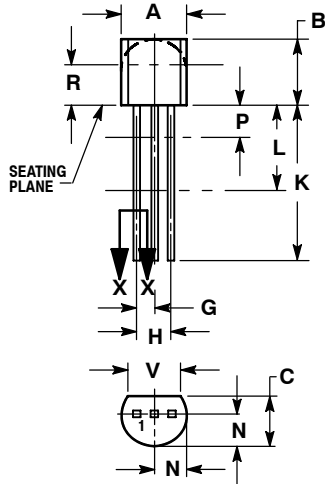


Figure 5. Active Region, Safe Operating Area

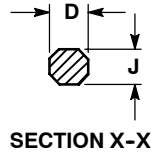
MPSA63, MPSA64

PACKAGE DIMENSIONS

TO-92 (TO-226)
CASE 29-11
ISSUE AM



STRAIGHT LEAD
BULK PACK

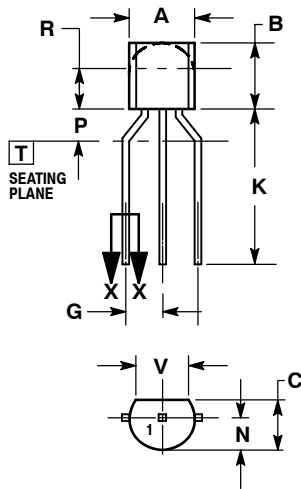


SECTION X-X

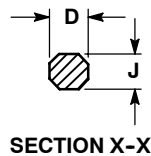
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.175 | 0.205 | 4.45 | 5.20 |
| B | 0.170 | 0.210 | 4.32 | 5.33 |
| C | 0.125 | 0.165 | 3.18 | 4.19 |
| D | 0.016 | 0.021 | 0.407 | 0.533 |
| G | 0.045 | 0.055 | 1.15 | 1.39 |
| H | 0.095 | 0.105 | 2.42 | 2.66 |
| J | 0.015 | 0.020 | 0.39 | 0.50 |
| K | 0.500 | --- | 12.70 | --- |
| L | 0.250 | --- | 6.35 | --- |
| N | 0.080 | 0.105 | 2.04 | 2.66 |
| P | --- | 0.100 | --- | 2.54 |
| R | 0.115 | --- | 2.93 | --- |
| V | 0.135 | --- | 3.43 | --- |



BENT LEAD
TAPE & REEL
AMMO PACK



SECTION X-X

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | 4.45 | 5.20 |
| B | 4.32 | 5.33 |
| C | 3.18 | 4.19 |
| D | 0.40 | 0.54 |
| G | 2.40 | 2.80 |
| J | 0.39 | 0.50 |
| K | 12.70 | --- |
| N | 2.04 | 2.66 |
| P | 1.50 | 4.00 |
| R | 2.93 | --- |
| V | 3.43 | --- |

STYLE 1:

1. EMITTER
2. BASE
3. COLLECTOR

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